

U.S. Application of 10/673,910 (MAISUDA et al.)  
Filed: September 30, 2003  
Our Ref.: 071469-0305914  
Title: Method for depositing metal layers using sequential  
flow deposition  
Pillsbury Winthrop, LLP Tel No.: 703-770-7788  
One (1) Replacement Sheet (Figures 6A & 6B)  
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FIG. 6B

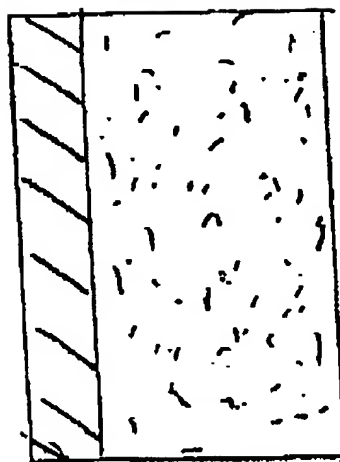
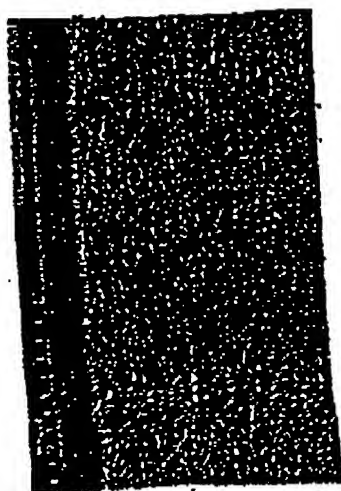


FIG. 6A

